

Renesas RA Family

System Specifications for Standard Boot Firmware

Introduction

This document describes the specification of standard boot firmware for Renesas RA microcontrollers. This document assumes that the reader has an understanding of specifications for Renesas RA products, FPSYS/FACI, and FCB.

Target Device

This document is for the RA2A1, RA4M1, RA4W1, RA6M1, RA6M2, RA6M3, and RA6T1 MCU Groups. This document will be revised to include other products as needed.

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1. Definition of Terms

The terminology used in this specification is defined in this section.

1.1 Flash Memory

The ROM area where program code is written is called the Code Flash. The ROM area where data is written is called the Data Flash. Both are called Flash Memory. The area used by user is called the User area. The area that stores configuration data is called the Config area.

Example: Figure 1 is an example of flash memory structure. Note that memory structure will differ from device to device.



Figure 1. Flash Memory Structure Example

1.2 Boot Firmware

The program included in the microcontroller to rewrite the flash memory is called the Boot Firmware.



1.3 SCI: Serial Communication Interface

The interface module which performs serial communication is called the Serial Communication Interface (SCI). This boot firmware uses the common SCI configured as UART (Universal Asynchronous Receiver/Transmitter).

1.4 AW: Access Window

The function that assigns accessible sectors to erase or write in code flash is called the Access Window (AW). This function allows access from start sector to end sector and disallows access to other areas. Users set a value corresponding to the "start sector" to the FAWS, and set a value corresponding to "end sector + 1" to the FAWE. If FSPR is 0, FAWS and FAWE cannot be changed. For details, please refer to the Renesas RA Flash Memory Programming Application Note.

| Sector No. | Base address | Size | Setting value |
|------------|--------------|-------|---------------|
| 0 | 0000000h | 8 KB | 000h |
| 1 | 00002000h | 8 KB | 001h |
| 2 | 00004000h | 8 KB | 002h |
| 3 | 00006000h | 8 KB | 003h |
| 4 | 00008000h | 8 KB | 004h |
| 5 | 0000A000h | 8 KB | 005h |
| 6 | 0000C000h | 8 KB | 006h |
| 7 | 0000E000h | 8 KB | 007h |
| 8 | 00010000h | 32 KB | 008h |
| 9 | 00018000h | 32 KB | 00Ch |
| 10 | 00020000h | 32 KB | 010h |
| 11 | 00028000h | 32 KB | 014h |
| : | : | : | : |
| 132 | 003F0000h | 32 KB | 1F8h |
| 133 | 003F8000h | 3 2KB | 1FCh |

 Table 1. Example of the RA6 Series Flash Memory Structure



Figure 2. Access Window Example: FAWS = 007h, FAWE = 014h



Table 2. Example of RA4 Series Flash Memory Structure

| Sector No. | Base address | Size | Setting value |
|------------|--------------|------|---------------|
| 0 | 0000000h | 2 KB | 000h |
| 1 | 00000800h | 2 KB | 002h |
| 2 | 00001000h | 2 KB | 004h |
| 3 | 00001800h | 2 KB | 006h |
| 4 | 00002000h | 2 KB | 008h |
| 5 | 00002800h | 2 KB | 00Ah |
| 6 | 00003000h | 2 KB | 00Ch |
| 7 | 00003800h | 2 KB | 00Eh |
| 8 | 00004000h | 2 KB | 010h |
| 9 | 00004800h | 2 KB | 012h |
| 10 | 00005000h | 2 KB | 014h |
| 11 | 00005800h | 2 KB | 016h |
| : | : | : | : |
| 510 | 000FF000h | 2 KB | 3FCh |
| 511 | 000FF800h | 2 KB | 3FEh |

Table 3. Example of RA2 Series Flash Memory Structure

| Sector No. | Base address | Size | Setting value |
|------------|--------------|------|---------------|
| 0 | 0000000h | 1 KB | 000h |
| 1 | 00000400h | 1 KB | 001h |
| 2 | 00000800h | 1 KB | 002h |
| 3 | 00000C00h | 1 KB | 003h |
| 4 | 00001000h | 1 KB | 004h |
| 5 | 00001400h | 1 KB | 005h |
| 6 | 00001800h | 1 KB | 006h |
| 7 | 00001C00h | 1 KB | 007h |
| 8 | 00002000h | 1 KB | 008h |
| 9 | 00002400h | 1 KB | 009h |
| 10 | 00002800h | 1 KB | 00Ah |
| 11 | 00002C00h | 1 KB | 00Bh |
| : | : | : | : |
| 1022 | 000FF800h | 1 KB | 3FEh |
| 1023 | 000FFC00h | 1 KB | 3FFh |



2. System Architecture

Boot firmware has a serial programming interface to send and receive flash control commands between the microcontroller and the flash programmer in serial programming mode. In debug mode, boot firmware only erases all of the User area and Config area. Boot firmware is embedded in the device.

2.1 Renesas RA4M1/RA4W1

Table 4. RA4 Series Serial Programming

| Operating mode | When VCC is higher than 2.4 V: High-speed mode | |
|-----------------------------|-------------------------------------------------|--|
| | When VCC is lower than 2.4 V: Middle-speed mode | |
| Supported communication | Two-wire UART, USB ^{*1} | |
| Main-OSC input | When using USB: Necessary ^{*2} | |
| | When not using USB: Unnecessary | |
| Operating voltage condition | VCC = 1.8 V–5.5 V ^{*3} | |

Notes:*1. For devices that have a UCKSEL register (in other words, devices where HOCO is selectable as USB clock source), boot firmware generates the USB clock from HOCO. Therefore, USB communication is not guaranteed in an environment where the accuracy of HOCO oscillation does not meet the standard of USB clock. For the accuracy of HOCO oscillation, refer to the device's electrical characteristics.

- *2. For devices that have a UCKSEL register (in other words, devices where HOCO is selectable as USB clock source), boot firmware can operate by HOCO even when using USB.
- *3. USB communication is not available when VCC < 3 V.



Figure 3. RA4 Series Flash System Architecture



2.2 Renesas RA2A1

Table 5. RA2A1 Serial Programming

| Operating mode | When VCC is higher than 2.4 V: High-speed mode When VCC is lower than 2.4 V: Middle-speed mode |
|-----------------------------|---------------------------------------------------------------------------------------------------|
| Supported communication | Two-wire UART |
| Main-OSC input | Unnecessary |
| Operating voltage condition | VCC = 1.8 V–5.5 V |



Figure 4. RA2A1 Flash System Architecture



2.3 Renesas RA6M1/RA6M2/RA6M3/RA6T1

Table 6. RA6 Series Serial Programming

| Operating mode | High-speed mode | |
|-----------------------------|---------------------------------------------------|--|
| Supported communication | Two-wire UART, USB | |
| Main-OSC input | When using USB: Necessary | |
| - | When not using USB: Unnecessary | |
| Operating voltage condition | VCC = 2.7 V–3.6 V. Same as device specification.* | |

Note: * USB communication is not available when VCC < 3.



Figure 5. RA6 Series Flash System Architecture



2.4 Mode Entry

Boot firmware selects Serial programming mode or Debug mode based on the MD pin level at reset timing. If the operating mode is Serial programming mode, boot firmware transitions to the Communication setting phase. If the operating mode isn't Serial programming mode, boot firmware erases all of the User area and Config area, and then goes into an infinite loop. If Security MPU is valid, boot firmware goes into an infinite loop without transition to either mode.



Figure 6. Flash Modes

3. Serial Programming Interface

3.1 Communication Mode

Boot firmware has interfaces for the following communication modes. Section 3.2.1 includes a flowchart for selecting the mode.

- Two-wire UART communication
- USB communication



3.1.1 Two-wire UART Communication

Boot firmware supports two-wire UART communication (Figure 7).



Figure 7. Two-Wire UART Communication

In Serial programming mode, boot firmware sets RxD to port-In for communication mode detection. Boot firmware selects UART communication and initializes the SCI by the detecting the falling edge of RxD.

Table 7. UART Settings

| Interface | SCI ch9 |
|-------------|---------------------------------|
| RxD | Reception and Transmission mode |
| TxD | Reception and Transmission mode |
| Baud rate | 9600 bps |
| Data length | 8 bits (LSB first) |
| Parity bit | None |
| Stop bit | 1 bit |

Communication speed is 9600 bps until the baud rate setting command is completed. Communication speed is changed to the intended rate after successful completion of the baud rate setting command (Figure 8).



Figure 8. Baud Rate Setting

When using UART communication, do not connect to flash programmer with the USB cable.

If the UART communication cable is unplugged during transmission, the result is undefined.

3.1.2 USB Communication

Boot firmware supports USB communication (Figure 9).



Figure 9. USB Communication



In Serial programming mode, boot firmware sets USB state to enumeration. Boot firmware selects USB communication and initiates communication by the detection of the "Configured" state.

| Interface | USBFS | |
|----------------------------------------------------|-------------------------------------------------------|--|
| VBUS | Input mode | |
| D+ | Input-Output mode | |
| D- | Input-Output mode | |
| Transfer rate | 12 Mbps (USB2.0 Full Speed) | |
| Device class | Communication device class (CDC) | |
| | SubClass: Abstract Control Model (ACM) | |
| | Protocol: Common AT commands | |
| Vendor ID | 045Bh (Renesas) | |
| Product ID | 0261h (RA USB Boot) | |
| Transfer mode | Control (in/out) | |
| | Bulk (in, out) | |
| | Interrupt (in) | |
| End points | RA4, RA6 series | |
| | EP0: Default control pipe, Control transfers (in/out) | |
| | EP1: TxD pipe, Bulk transfers (in) 64 bytes | |
| | EP2: RxD pipe, Bulk transfers (out) 64 bytes | |
| | EP6: Control pipe, Interrupt transfers (in) | |
| RA2A1 | | |
| EP0: Default control pipe, Control transfers (in/o | | |
| EP4: TxD pipe, Bulk transfers (in) 64 bytes | | |
| | EP5: RxD pipe, Bulk transfers (out) 64 bytes | |
| | EP6: Control pipe, Interrupt transfers (in) | |

Table 8. USB Settings

Clock input from the Main clock oscillator with the frequencies listed in Table 9 is necessary to generate the clock for USB communication.

Table 9. Clock Frequencies for USB Communication

| Series | Frequency | |
|---------------------------|-----------------------------------------------------------------|--|
| RA6 | 8, 10, 12, 15, 16, 20, or 24 MHz | |
| RA4/2 w/o UCKSEL register | 4, 6, 8 or 12 MHz | |
| RA4/2 w/ UCKSEL register | N/A (Clock for USB is generated from HOCO, not Main oscillator) | |

When using USB communication, release the reset after connecting to the flash programmer with the USB cable.

If the USB cable is unplugged during transmission, the result is undefined.

When using USB communication, boot firmware notifies host that the power mode is self-powered.

3.2 **Operating Procedures**

3.2.1 Communication Setting Phase

After reset release, boot firmware selects the communication mode (two-wire UART or USB) by the flowchart in Figure 10. After communication setting and the receipt of Generic code via the selected communication method, boot firmware transitions to the Authentication phase. However, if the ID code stored in the device is all "1", boot firmware transitions to the Command acceptance phase directly.

3.2.1.1 Selection of Communication Mode

Table 10. Communication Mode Selection

| Condition | Communication mode |
|------------------------------------------------------------|-------------------------------------------|
| Detection of High level on MD (P201): Single chip mode | Unexpected mode entry (-> Software reset) |
| Detection of "Configured" state (Enumeration is completed) | USB mode |
| Detection of a falling edge on RxD | UART mode |

* P201: MD signal is assigned to P201.





Figure 10. Selecting Communication Mode



3.2.1.2 Setting Up Two-wire UART Communication

To use UART communication, the flash programmer sends 0x00 data (low pulse) at 9600 bps at least two times. (If the environment is noisy, retry sending the low pulse until ACK is received.) Boot firmware selects UART communication and initializes the SCI when it detects the falling edge on RxD. After that, boot firmware receives the second low pulse as 0x00 data in SCI, then returns the ACK, receives the Generic code, then returns the Boot code. This completes communication setting.



Figure 11. Two-Wire UART Set Up

3.2.1.3 Setting Up USB Communication

Boot firmware selects USB communication when it detects the Configured state. After that, boot firmware receives 0x00 data from the RxD pipe, then returns the ACK, receives the Generic code, then returns the Boot code. This completes communication settings.



Figure 12. USB Communication Set Up

3.2.2 Authentication Phase

Boot firmware authenticates ID code in this phase. This phase can accept only the Authentication command. If the Authentication command passes successfully, boot firmware transitions to Command acceptance phase.

3.2.3 Command Acceptance Phase

This phase can accept all commands except the Authentication command. The flash programmer can judge if the current phase is Command acceptance phase or Authentication phase by the result of an Inquiry command.



3.2.4 State Transitions



Figure 13. State Transitions



3.2.5 Beginning Communication

3.2.5.1 If ID Code is Already Stored [Secure]



Figure 14. Beginning Communication (Secure)







Figure 15. Beginning Communications (Non-secure)

3.3 Packet Format

Be sure to follow this format. If the boot firmware receives a packet of more than 1024 bytes, the boot firmware may not be able to reply.



3.3.1 Command Packet

The flash programmer sends data of a command packet to the microcontroller in the following format.

| S | L | L | С | Command information | S | E |
|---|---|---|---|-----------------------------------|---|---|
| O | N | N | О | (flexible length [max:255 bytes]) | U | T |
| Н | Н | L | М | (flexible length [max:255 bytes]) | Μ | |

| Symbol | Size | Code | Description | | |
|-----------------|--------|----------|-----------------------------------------------------------|---------------------------------|--|
| SOH 1 byte 0x01 | | 0x01 | Start of command packet | | |
| LNH | 1 byte | - | Packet length (Length = COM + Command information) [High] | | |
| LNL | 1 byte | - | Packet length (Length = COM + Command information) [Low] | | |
| COM | 1 byte | - | Command code (refer to section 3.4.1) | | |
| Command | | | Command information [Max: 255 bytes] | | |
| information | - | | Example: For write command: Write destination address | | |
| Information | | | For erase command: Erase target address | | |
| | | | Sum data of LNH + LNL + COM + Command information | | |
| | | | | (expressed as two's complement) | |
| SUM | 1 byte | 1 byte - | Example: LNH + LNL + COM + Command information(1) + | | |
| | - | - | Command information(2) + + Command information(n) + | | |
| | | | SUM = 0x00 | | |
| ETX | 1 byte | 0x03 | End of packet | | |

Note: If the packet length is 0 or over 1024, the value of RES will not be defined.

3.4 Communication Command

3.4.1 List of Command Codes

Table 11. Command Codes

| Command code | Command name | Description |
|--------------|----------------------------------|------------------------------------------------|
| 0x00 | Inquiry command | Return ACK (to determine the current phase) |
| 0x12 | Erase command | Erase data on target area |
| 0x13 | Write command | Write data on target area |
| 0x15 | Read command | Read data on target area |
| 0x30 | ID authentication command | Authenticate ID for connection with the device |
| 0x34 | Baud rate setting command | Set baud rate for UART |
| 0x3A | Signature request command | Get signature information |
| 0x3B | Area information request command | Get area information |



3.4.2 List of Status Codes

Table 12. Status Codes

| Status code | Description |
|---------------------|-----------------------------------------------------------|
| 0x00 Command code | OK (ongoing normally): used in Response code [RES] |
| 0x80 Command code | ERR (occurrence of an error): used in Response code [RES] |
| 0x00 | OK (successful completion) |
| 0xC0 | Unsupported command error |
| 0xC1 | Packet error (Illegal length, Missing ETX, and so forth) |
| 0xC2 | Checksum error |
| 0xC3 | Flow error |
| 0xD0 | Address error |
| 0xD4 | Baud rate margin error |
| 0xDA | Protection error |
| 0xDB | ID mismatch error |
| 0xDC | Serial programming disable error |
| 0xE1 | Erase error (*1) |
| 0xE2 | Write error (*1) |
| 0xE7 | Sequencer error (*1) |

Note: *1 For Erase command or Write command, boot firmware checks the status registers of the flash sequencer (FACI or FCB) and returns the following status.

| Status | Flash process | Condition |
|-----------------|----------------|-------------------------------------|
| Erase error | RA2/RA4 Series | If ERERR is detected |
| EIASE EIIOI | RA6 Series | If ERSERR is detected |
| Write error | RA2/RA4 Series | If PRGERR or PRGERR01 are detected |
| white error | RA6 Series | If PRGERR is detected |
| Cogueroer error | RA2/RA4 Series | If ILGLERR or EILGLERR are detected |
| Sequencer error | RA6 Series | If ILGLERR or FLWEERR are detected |

3.4.3 Executable Command in Each Phase

Table 13. Executable Commands

| Command | Communication setting phase | Authentication phase | Command acceptance phase |
|----------------------------------|-----------------------------|----------------------|--------------------------|
| Inquiry command | NG (*1) | Flow error | OK |
| Erase command | NG (*1) | Flow error | OK |
| Write command | NG (*1) | Flow error | OK |
| Read command | NG (*1) | Flow error | OK |
| ID authentication command | NG (*1) | OK | Flow error |
| Baud rate setting command | NG (*1) | Flow error | OK |
| Signature request command | NG (*1) | Flow error | OK |
| Area information request command | NG (*1) | Flow error | OK |

Note: *1 Boot firmware does not return any data packet.

3.4.4 Unsupported Command

If boot firmware receives the command packet of a command code that is not defined in section 3.4.1, it returns the unsupported command error, then goes back to the Wait for command state.



3.4.4.1 Command Processing Procedure



Figure 16. Unsupported Command Processing

3.4.4.2 Command Packet

| S | L | L | С | S | Е |
|---|---|---|---|---|---|
| 0 | Ν | Ν | 0 | U | Т |
| н | Н | L | М | М | Х |

| SOH | (1 byte) | 0x01 |
|-----|----------|-------------------------------------------|
| LNH | (1 byte) | Length high |
| LNL | (1 byte) | Length low |
| COM | (1 byte) | Command code not defined in section 3.4.1 |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |

3.4.4.3 Data Packet [Status ERR]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|----------------------------------------------------------------------------------------------------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0x80 COM (ERR) |
| STS | (1 byte) | Status code 0xC0 (Unsupported command error) 0xC1 (Packet error) 0xC2 (Checksum error) 0xC3 (Flow error) |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |

3.4.4.4 Status Code from Microcontroller [Priority high: 1 -> low: 10]

Table 14. Unsupported Command Status Codes

| Condition | Status | Priority | Code |
|-------------------------------------------------------------------------------------------|---------------------------|----------|------|
| If COM in the received packet is undefined code | Unsupported command error | 4 | 0xC0 |
| If LNH and LNL in the received packet are different from defined values | Packet error | 3 | 0xC1 |
| If the received packet does not have ETX | | 1 | |
| If SUM in the received packet is different from the value calculated by the boot firmware | Checksum error | 2 | 0xC2 |

3.4.5 Inquiry Command

The Inquiry command is used to check if boot firmware is in Command acceptance phase or not. This command can be performed only in Command acceptance phase.



3.4.5.1 Command Processing Procedure



Figure 17. Inquiry Command Processing

3.4.5.2 Command Packet

| S | L | L | С | S | Е |
|---|---|---|---|---|---|
| 0 | Ν | Ν | 0 | U | Т |
| н | Н | L | М | М | Х |

| SOH | (1 byte) | 0x01 |
|-----|----------|------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x01 |
| COM | (1 byte) | 0x00 (Inquiry command) |
| SUM | (1 byte) | 0xFF |
| ETX | (1 byte) | 0x03 |

3.4.5.3 Data Packet [Status OK]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|-------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0x00 (OK) |
| STS | (1 byte) | Status code |
| | | 0x00 (OK) |
| SUM | (1 byte) | 0xFE |
| ETX | (1 byte) | 0x03 |

3.4.5.4 Data Packet [Status ERR]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|-----------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0x80 (ERR) |
| STS | (1 byte) | Status code |
| | | 0xC1 (Packet error) |
| | | 0xC2 (Checksum error) |
| | | 0xC3 (Flow error) |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |



3.4.5.5 Status Code from Microcontroller [Priority High: 1 -> low: 10]

Table 15. Inquiry Status Codes

| Condition | Status | Priority | Code |
|-------------------------------------------------------------------------|------------|----------|------|
| If the state is Command acceptance phase | OK | 5 | 0x00 |
| If LNH and LNL in the received packet are different from defined values | Packet | 3 | 0xC1 |
| If the received packet does not have ETX | error | 1 | UXCI |
| If SUM in the received packet is different from the value calculated by | Checksum | 2 | 0xC2 |
| the boot firmware | error | Z | UXC2 |
| If the state is Authentication phase | Flow error | 4 | 0xC3 |

3.4.6 Erase Command

The Erase command erases data in the designated area of the flash memory. The alignment of the target addresses follows the area information returned by the Area information request command. Erasures are executed in order from the start address to the end address by the erase access unit. This command can be performed only in Command acceptance phase.

3.4.6.1 Command Processing Procedure



Figure 18. Erase Command Processing

3.4.6.2 Command Packet

| S | | | | | | | |
|---|---|---|---|---|---|---|---|
| 0 | Ν | Ν | 0 | А | А | U | Т |
| Н | Н | L | М | D | D | М | Х |

| SOH | (1 byte) | 0x01 |
|-----|-----------|----------------------------------------------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x09 |
| COM | (1 byte) | 0x12 (Erase command) |
| SAD | (4 bytes) | Start address Example: 0000_4000h -> 0x00, 0x00, 0x40, 0x00 |
| EAD | (4 bytes) | End address Example: 003F_FFFFh -> 0x00, 0x3F, 0xFF, 0xFF |
| SUM | (1 bytes) | Sum data |
| ETX | (1 bytes) | 0x03 |



3.4.6.3 Data Packet [Status OK]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|--------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0x12 (OK) |
| STS | (1 byte) | Status code 0x00 (OK) |
| | | |
| SUM | (1 byte) | 0xEC |
| ETX | (1 byte) | 0x03 |

3.4.6.4 Data Packet [Status ERR]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|-------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0x92 (ERR) |
| STS | (1 byte) | Status code |
| | | 0xC1 (Packet error) |
| | | 0xC2 (Checksum error) |
| | | 0xC3 (Flow error) |
| | | 0xD0 (Address error) |
| | | 0xDA (Protection error) |
| | | 0xE1 (Erase error) |
| | | 0xE2 (Write error) |
| | | 0xE7 (Sequencer error) |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |



3.4.6.5 Status Code from Microcontroller [Priority High: 1 -> Low: 10]

Table 16. Erase Status Codes

| Condition | Status | Priority | Code |
|----------------------------------------------------------------------------|--------------|----------|------|
| Successful completion | OK | 8 | 0x00 |
| If LNH and LNL in the received packet are different from defined values | Packet error | 3 | 0xC1 |
| If the received packet does not have ETX | | 1 | |
| If SUM in the received packet is different from the value calculated by | Checksum | 2 | 0xC2 |
| the boot firmware | error | | |
| If the state is Authentication phase | Flow error | 4 | 0xC3 |
| If the start address or the end address does not belong to any areas *1 | Address | 5 | 0xD0 |
| The start address is in a different area from the end address *1 | error | 5 | |
| This command isn't available for this area | | 5 | |
| The start address is bigger than the end address | | 5 | |
| If the start address or the end address does not match the alignment of | | 5 | |
| the area | | | |
| If the target area is not entirely within the Access Window in the case of | Protection | 6 | 0xDA |
| User area in code flash | error | | |
| If the target area is Config area, and the FSPR bit is 0 | | 6 | |
| If the erase error occurs | Erase error | 7 | 0xE1 |
| If the write error occurs | Write error | 7 | 0xE2 |
| If the sequencer error occurs | Sequencer | 7 | 0xE7 |
| | error | | |

Note: *1 Scope of each area is subject to area information request command

3.4.7 Write Command

The Write command receives write data from the flash programme, and writes those data to the flash memory. The alignment of the target address follows the area information returned by the Area information request command. Writes are executed in order from start address to end address by the write access unit. This command can be performed only in the Command acceptance phase.



3.4.7.1 Command Processing Procedure



Figure 19. Write Command Processing

3.4.7.2 Command Packet

| | | | | | | | Е |
|---|---|---|---|---|---|---|--------|
| 0 | Ν | Ν | 0 | А | А | U | T X |
| Н | Н | L | М | D | D | М | Х |

| SOH | (1 byte) | 0x01 |
|-----|-----------|----------------------------------------------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x09 |
| COM | (1 byte) | 0x13 (Write command) |
| SAD | (4 bytes) | Start address Example: 0000_4000h -> 0x00, 0x00, 0x40, 0x00 |
| EAD | (4 bytes) | End address Example: 003F_FFFFh -> 0x00, 0x3F, 0xFF, 0xFF |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |



3.4.7.3 Data Packet [Write Data]

| S | L | | | D | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | | U | Т |
| D | н | L | S | Т | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|-----------|--------------|
| LNH | (1 byte) | N + 1 (High) |
| LNL | (1 byte) | N + 1 (Low) |
| RES | (1 byte) | 0x13 (OK) |
| DAT | (N bytes) | Write data |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |

Note: N = 1–1024

3.4.7.4 Data Packet [Status OK]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|--------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0x13 (OK) |
| STS | (1 byte) | Status code 0x00 (OK) |
| SUM | (1 byte) | 0xEB |
| ETX | (1 byte) | 0x03 |

3.4.7.5 Data Packet [Status ERR]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|-------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0x93 (ERR) |
| | | Status code |
| | | 0xC1 (Packet error) |
| | | 0xC2 (Checksum error) |
| | | 0xC3 (Flow error) |
| STS | (1 byte) | 0xD0 (Address error) |
| | | 0xDA (Protection error) |
| | | 0xE1 (Erase error) |
| | | 0xE2 (Write error) |
| | | 0xE7 (Sequencer error) |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |



3.4.7.6 Status Code from Microcontroller [Priority High: 1 -> low: 10]

Table 17. Write Status Codes

| Condition | Status | Priority | Code |
|----------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|----------|------|
| Successful completion | OK | 9 | 0x00 |
| If LNH and LNL in the received packet are different from defined values | | 3 | |
| If the received packet does not have ETX | | 1 | |
| If the number of data of all data packets received from flash programmer is beyond the number of write data designated by the command packet | Packet error | 7 | 0xC1 |
| If the write length does not match the write access unit of the area | | 7 | |
| If the RES of received data packet isn't OK | | 7 | |
| If SUM in the received packet is different from the value calculated by the boot firmware | Checksum error | 2 | 0xC2 |
| If the state is Authentication phase | Flow error | 4 | 0xC3 |
| If the start address or the end address does not belong to any areas *1 | | 5 | |
| If the start address is in a different area from the end address *1 | | 5 | |
| If this command isn't available for this area | Address | 5 | 0xD0 |
| If the start address is bigger than the end address | error | 5 | UXDU |
| If the start address or the end address does not match to the alignment of the area | | 5 | |
| If the target area is not entirely within the Access Window in the case of User area in code flash | Protection | 6 | 0xDA |
| If the target area contain FAWS or FAWE or BTFLG in Config area, and the FSPR bit is 0 | error | 6 | UXDA |
| If the erase error occurs | Erase error | 8 | 0xE1 |
| If the write error occurs | Write error | 8 | 0xE2 |
| If the sequencer error occurs | Sequencer error | 8 | 0xE7 |

Note: *1 Scope of each area is subject to area information request command

3.4.7.7 Basic Precautions for Write Command

If you write any value except 0xFFFF to SECMPUAC, boot firmware will hang after the next reset release (refer to section 2.4).

If you write 0 to ID[127] in Config area, the device will lose the ability to perform ID authentication (ID authentication command will return the serial programming disable error) (refer to section 3.4.9).

If you write 0 to ID[126] in Config area, the device will lose the ability of total area erasure by ID authentication command (refer to section 3.4.9).

In addition, device configuration data may be assigned in the Option-Setting Memory area and Config area. The result of writing to an unassigned address depends on each device. Therefore, these areas should be rewritten only after careful review of device documents.

3.4.8 Read Command

The Read command reads data from a designated area in the flash memory and sends that data to the flash programmer. The target address can be designated by 1-byte units. Reads are executed in order from start address to end address by 1 byte. This command can be performed only in Command acceptance phase.



3.4.8.1 Command Processing Procedure



Figure 20. Read Command Processing

3.4.8.2 Command Packet

| | | | | | Е | | |
|---|---|---|---|---|--------|---|---|
| 0 | Ν | Ν | 0 | А | A D | U | Т |
| Н | н | L | М | D | D | М | Х |

| SOH | (1 byte) | 0x01 |
|-----|-----------|----------------------------------------------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x09 |
| COM | (1 byte) | 0x15 (Read command) |
| SAD | (4 bytes) | Start address Example: 0000_4000h -> 0x00, 0x00, 0x40, 0x00 |
| EAD | (4 bytes) | End address Example: 003F_FFFFh -> 0x00, 0x3F, 0xFF, 0xFF |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |

3.4.8.3 Data Packet [Read Data]

| S | L | L | R | D | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | А | U | Т |
| D | Н | L | S | Т | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|-----------|--------------|
| LNH | (1 byte) | N + 1 (High) |
| LNL | (1 byte) | N + 1 (Low) |
| RES | (1 byte) | 0x15 (OK) |
| DAT | (N bytes) | Read data |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |



Note: N = 1-1024

3.4.8.4 Data Packet [Status OK]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 | | | | | |
|-----|----------|-------------|--|--|--|--|--|
| LNH | (1 byte) | 0x00 | | | | | |
| LNL | (1 byte) | 0x02 | | | | | |
| RES | (1 byte) | 0x15 (OK) | | | | | |
| STS | (1 byte) | Status code | | | | | |
| | | 0x00 (OK) | | | | | |
| SUM | (1 byte) | 0xE9 | | | | | |
| ETX | (1 byte) | 0x03 | | | | | |

3.4.8.5 Data Packet [Status ERR]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|-----------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0x95 (ERR) |
| STS | (1 byte) | Status code |
| | | 0xC1 (Packet error) |
| | | 0xC2 (Checksum error) |
| | | 0xC3 (Flow error) |
| | | 0xD0 (Address error) |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |

3.4.8.6 Status Code from Microcontroller [Priority High: 1 -> low: 10]

Table 18. Read Status Codes

| Condition | Status | Priority | Code |
|-------------------------------------------------------------------------------------------|-------------------|----------|-------|
| If LNH and LNL in the received packet are different from defined values | | 3 | |
| If the received packet does not have ETX | Packet error | 1 | 0xC1 |
| If the RES of received data packet isn't OK | | 6 | |
| If SUM in the received packet is different from the value calculated by the boot firmware | Checksum error | 2 | 0xC2 |
| If the state is Authentication phase | Flow error | 4 | 0xC3 |
| If the start address or the end address does not belong to any areas *1 | Address | 5 | 0,400 |
| If the start address is a different kind of area from the end address *1 | error | 5 | 0xD0 |
| If the start address is bigger than the end address | | 5 | |

Note: *1. Scope of each area is subject to area information request command.

3.4.9 ID Authentication Command

The ID authentication command compares the ID code stored in the device with the ID code received from the flash programmer. The result is sent to the flash programmer. This command can be performed only in Authentication phase.



Table 19. ID Authentication

| Condition | | Result | | | | | |
|--------------------------|--------------------------|----------------------------------------------------------|--|--|--|--|--|
| Stored ID[127] = 0 | | Go into an infinite loop | | | | | |
| Stored ID[127:126] = 10b | | Compare the received ID and the stored ID | | | | | |
| Stored ID[127:126] = 11b | Received ID != ALeRASE | Compare the received ID and the stored ID | | | | | |
| | Received ID = ALeRASE | Erase all User area and Config area [Total area erasure] | | | | | |
| | | -> Transition to Command acceptance phase | | | | | |
| Compare | Received ID != stored ID | Go into an infinite loop | | | | | |
| | Received ID = stored ID | Transition to Command acceptance phase | | | | | |

Note: *ALeRASE: 0x41, 0x4C, 0x65, 0x52, 0x41, 0x53, 0x45, 0xFF, 0x



Figure 21. ID Authentication



3.4.9.1 Command Processing Procedure



Figure 22. ID Authentication Command Processing

3.4.9.2 Command Packet

| S | L | L | С | Authentication | S | Е |
|---|---|---|---|----------------|---|---|
| 0 | Ν | Ν | 0 | | U | Т |
| Н | Н | L | Μ | phase | Μ | Х |

| SOH | (1 byte) | 0x01 |
|-----|-----------|----------------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x11 |
| COM | (1 byte) | 0x30 (ID authentication command) |
| IDC | (16 byte) | ID code |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |

Example: when stored ID = "0xF0F1F2F3_E4E5E6E7_D8D9DADB_CCCDCECF",

Flash programmer sends IDC in order of "0xF0", "0xF1", "0xF2", "0xF3", "0xE4", "0xE5", "0xE6", "0xE7", "0xD8", "0xD8", "0xD8", "0xCD", "0xCE", "0xCE", "0xCF".

Stored ID:

| | ID[127:96] | | | | ID[95:64] | | | ID[63:32] | | | | ID[31:0] | | | |
|----|------------|----|----|----|-----------|----|----|-----------|----|----|----|----------|----|----|----|
| F0 | F1 | F2 | F3 | E4 | E5 | E6 | E7 | D8 | D9 | DA | DB | CC | CD | CE | CF |

Order of sending IDC for ID authentication:

| 1st | 2nd | 3rd | 4th | 5th | 6th | 7th | 8th | 9th | 10th | 11th | 12th | 13th | 14th | 15th | 16th |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|------|------|------|------|------|------|------|
| F0 | F1 | F2 | F3 | E4 | E5 | E6 | E7 | D8 | D9 | DA | DB | CC | CD | CE | CF |

Example: for Total area erasure:

Flash programmer sends IDC in order of "0x41", "0x4C", "0x65", "0x52", "0x41", "0x53", "0x45", "0xFF", "0xFF ~, "0xFF ~, "0xFF ~, "0xFF", "0xFF ~, "0xFF ~, "0

Order of sending IDC for Total area erasure:

| 1st | 2nd | 3rd | 4th | 5th | 6th | 7th | 8th | 9th | 10th | 11th | 12th | 13th | 14th | 15th | 16th |
|-----|-----|-----|-----|-----|-----|-----|-----|-----|------|------|------|------|------|------|------|
| 41 | 4C | 65 | 52 | 41 | 53 | 45 | FF | FF | FF | FF | FF | FF | FF | FF | FF |



3.4.9.3 Data Packet [Status OK]

| S | L | L | R | S | S | Е |
|---|---|-------------|---|---|---|---|
| 0 | Ν | L N L | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|--------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0x30 (OK) |
| STS | (1 byte) | Status code 0x00 (OK) |
| SUM | (1 byte) | 0xCE |
| ETX | (1 byte) | 0x03 |

3.4.9.4 Data Packet [Status ERR]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0xB0 (ERR) |
| STS | (1 byte) | Status code 0xC1 (Packet error) 0xC2 (Checksum error) 0xC3 (Flow error) 0xDA (Protection error) 0xDB (ID mismatch error) 0xDC (Serial programming disable error) 0xE1 (Erase error) 0xE2 (Write error) 0xE7 (Sequencer error) |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |



3.4.9.5 Status Code from Microcontroller [Priority High: 1 -> Low: 10]

Table 20. ID Authentication Status Codes

| Condition | Status | Priority | Code |
|------------------------------------------------------------------|-------------------|----------|------|
| For ALeRASE, if erasure of all User area and Config area is done | OK | 8 | 0x00 |
| If the received ID matches the stored ID | OK | 10 | 0x00 |
| If LNH and LNL in the received packet are different from defined | Packet error | 3 | 0xC1 |
| values | | | |
| If the received packet does not have ETX | | 1 | |
| If SUM in the received packet is different from the value | Checksum error | 2 | 0xC2 |
| calculated by the boot firmware | | | |
| If the state is Command acceptance phase | Flow error | 4 | 0xC3 |
| For ALeRASE, if the FSPR bit is 0 | Protection error | 6 | 0xDA |
| If the received ID is different from the stored ID | ID mismatch error | 9 | 0xDB |
| If the highest-order bit of stored ID is "0" | Serial | 5 | 0xDC |
| | programming | | |
| | disable error | | |
| For ALeRASE, if an erase error occurs | Erase error | 7 | 0xE1 |
| For ALeRASE, if a write error occur | Write error | 7 | 0xE2 |
| For ALeRASE, if a sequencer error occurs. | Sequencer error | 7 | 0xE7 |

3.4.10 Baud Rate Setting Command

The Baud rate setting command receives baud rate data and changes the UART baud rate of the device. If an error occurs, the baud rate is not changed. This command can be performed only in Command acceptance phase. This command does not change the communication speed of USB communication.

3.4.10.1 Command Processing Procedure



Figure 23. Baud Rate Setting Command Processing



3.4.10.2 Command Packet

| S | L | L | С | В | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | 0 | R | U | Т |
| Н | Н | L | М | Т | М | Х |

| SOH | (1 byte) | 0x01 |
|-----|-----------|-------------------------------------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x05 |
| COM | (1 byte) | 0x34 (Baud rate setting command) |
| BRT | (4 bytes) | UART baud rate [bps] Example: 2 Mbps (2000000 bps) |
| | | -> 0x00, 0x1E, 0x84, 0x80 |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |

3.4.10.3 Data Packet [Status OK]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|--------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0x34 (OK) |
| STS | (1 byte) | Status code 0x00 (OK) |
| SUM | (1 byte) | 0xCA |
| ETX | (1 byte) | 0x03 |

3.4.10.4 Data Packet [Status ERR]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|-------------------------------------------------------------------------------------------------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0xB4 (ERR) |
| STS | (1 byte) | Status code 0xC1 (Packet error) 0xC2 (Checksum error) 0xC3 (Flow error) 0xD4 (Baud rate margin error) |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |



3.4.10.5 Status Code from Microcontroller [Priority High: 1 -> low: 10]

Table 21. Baud Rate Setting Status Codes

| Condition | Status | Priority | Code |
|----------------------------------------------------------------------------------------------|------------------------|----------|------|
| Started the baud rate setting | OK | 6 | 0x00 |
| If LNH and LNL in the received packet are different from defined values | Packet error | 3 | 0xC1 |
| If the received packet does not have ETX | | 1 | |
| If SUM in the received packet is different from the value calculated by the boot firmware | Checksum error | 2 | 0xC2 |
| If the state is Authentication phase | Flow error | 4 | 0xC3 |
| If the baud rate error exceeds acceptable range (4%) | | | |
| If the BRT value is 0 | Baud rate margin error | 5 | 0xD4 |
| If the BRT value exceeds the RMB value | | | |

3.4.10.6 Baud Rate Setting Values



Figure 24. Baud Rate Setting Values

Table 22. Baud Rate Setting

| Process | Condition | Setting value |
|----------------------------------------------|-----------------------------|-----------------------------------------------------------------------|
| Selection of base clock | In case of (SCI / BRT) < 32 | ABCS = 1 |
| (ABCS setting) | Otherwise | ABCS = 0 |
| Selection of clock division (CKS setting) | - | CKS[1:0] = 00b |
| Adjustment of bit rate | In case of (SCI / BRT) < 32 | BRR[7:0] = 00h |
| (BRR setting) | Otherwise | BRR[7:0] = (SCI / BRT) / 32 - 1 |
| | * If BRR is overflow | BRR[7:0] = FFh |
| Adjustment of modulation duty (MDDR setting) | In case of (SCI / BRT) < 32 | Baud rate = (SCI / (BRR+1)) / 16 MDDR[7:0] = 256 * BRT / baud rate |
| | Otherwise | Baud rate = (SCI / (BRR+1)) / 32 MDDR[7:0] = 256 * BRT / baud rate |
| | * If MDDR is overflow | MDDR[7:0] = (non-use) * disable the adjustment by MDDR |
| | * If MDDR < 128 | MDDR[7:0] = 80h |

Note: SCI: SCI operating clock frequency [Hz] BRT: Intended baud rate [bps]



Example: Table 23 and Table 24 show typical settings for baud rate.

| Intended baud rate | ABCS | CKS[1:0] | BRR[7:0] | MDDR[7:0] | Accuracy |
|--------------------|------|----------|----------|------------|----------|
| 9600 | 0 | 00b | C2h | FFh | -0.3% |
| 100000 | 0 | 00b | 00h | 88h | -0.4% |
| 1500000 | 0 | 00b | 00h | CCh | -0.4% |
| 2000000 | 1 | 00b | 00h | 88h | -0.4% |
| 300000 | 1 | 00b | 00h | CCh | -0.4% |
| 3500000 | 1 | 00b | 00h | EEh | -0.4% |
| 3750000 | 1 | 00b | 00h | (Not used) | 0.0% |

| Intended baud rate | ABCS | CKS[1:0] | BRR[7:0] | MDDR[7:0] | Accuracy |
|--------------------|---------|----------|----------|------------|----------|
| 9600 | 0 | 00b | 4Dh | FFh | -0.3% |
| 1000000 | 1 | 00b | 00h | AAh | -0.4% |
| 1500000 | 1 | 00b | 00h | (Not used) | 0.0% |
| 200000 | disable | disable | disable | disable | - |

3.4.11 Signature Request Command

The Signature request command sends information about the device signature to the flash programmer. This command can be performed in Command acceptance phase.

3.4.11.1 Command Processing Procedure



Figure 25. Signature Request Command Processing

3.4.11.2 Command Packet

| S | L | L | С | S | Е |
|---|---|---|---|---|---|
| 0 | Ν | Ν | 0 | U | Т |
| н | Н | L | М | М | Х |

| SOH | (1 byte) | 0x01 |
|-----|----------|----------------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x01 |
| COM | (1 byte) | 0x3A (Signature request command) |
| SUM | (1 byte) | 0xC5 |
| ETX | (1 byte) | 0x03 |



3.4.11.3 Data Packet [Signature]

| S | L | L | R | S | R | Ν | Т | В | S | Е |
|-------------|---|---|---|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | С | Μ | 0 | Υ | F | U | Т |
| S O D | н | L | S | Ι | В | А | Ρ | V | Μ | Х |

| - | | |
|-----|-----------|--------------------------------------------------------|
| SOD | (1 byte) | 0x81 |
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x0D |
| RES | (1 byte) | 0x3A (OK) |
| SCI | (4 bytes) | SCI operating clock frequency [Hz] |
| | | Example: 20 MHz (20000000 Hz) |
| | | -> 0x01, 0x31, 0x2D, 0x00 |
| RMB | (4 bytes) | Recommended maximum UART baud rate of the device [bps] |
| | | Example: 2 Mbps (2000000 bps) |
| | | -> 0x00, 0x1E, 0x84, 0x80 |
| NOA | (1 byte) | Number of recordable areas |
| | | Example: If device has following areas |
| | | 0. User area in Code flash (1st) |
| | | 1. User area in Code flash (2nd) |
| | | 2. User area in Data flash |
| | | 3. Config area |
| | | -> 0x04 |
| TYP | (1 byte) | Type code |
| | | 0x02 (RA MCU + RA2/RA4 Series) |
| | | 0x03 (RA MCU + RA6 Series) |
| BFV | (2 byte) | Boot firmware version |
| | | Example: Ver10.8 -> 0x0A, 0x08 |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |

3.4.11.4 Data Packet [Status ERR]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | Н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 |
|-----|----------|----------------------------------------------------------------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| RES | (1 byte) | 0xBA (ERR) |
| STS | (1 byte) | Status code 0xC1 (Packet error) 0xC2 (Checksum error) 0xC3 (Flow error) |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |

3.4.11.5 Status Code from Microcontroller [Priority High: 1 -> low: 10]

Table 25. Signature Request Status Codes

| Condition | Status | Priority | Code |
|-------------------------------------------------------------------------|--------------|----------|------|
| If LNH and LNL in the received packet are different from defined values | Packet error | 3 | 0xC1 |
| If the received packet does not have ETX | Packet entor | 1 | UXCT |
| If SUM in the received packet is different from the value calculated by | Checksum | 2 | 0xC2 |
| the boot firmware | error | 2 | UXC2 |
| If the state is Authentication phase | Flow error | 4 | 0xC3 |



3.4.12 Area Information Request Command

The Area information request command sends information about the designated area to the flash programmer. The alignment of the target address of Erase command and Write command will follow this area information. This command can be performed only in Command acceptance phase.

3.4.12.1 Command Processing Procedure



Figure 26. Area Information Request Command Processing

3.4.12.2 Command Packet

| S | L | L | С | Ν | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | 0 | U | U | Т |
| Н | Н | L | М | Μ | М | Х |

| SOH | (1 byte) | 0x01 |
|-----|----------|-----------------------------------------|
| LNH | (1 byte) | 0x00 |
| LNL | (1 byte) | 0x02 |
| COM | (1 byte) | 0x3B (Area information request command) |
| NUM | (1 byte) | Area number [0–NOA-1] |
| SUM | (1 byte) | Sum data |
| ETX | (1 byte) | 0x03 |



3.4.12.3 Data Packet [Area information]

| S | L | L | R | Κ | S | Е | Е | W | S | Е |
|-------------|---|---|---|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | 0 | А | А | А | А | U | Т |
| S O D | Н | L | S | А | D | D | U | U | Μ | Х |

| (1 byte) | 0x81 |
|--------------|-----------------------------------------------------------------------------------------------------------------|
| (1 byte) | 0x00 |
| (1 byte) | 0x12 |
| (1 byte) | 0x3B (OK) |
| | Kind of area |
| (1 h) (1 h) | 0x00 (User area in Code flash) |
| (T byte) | 0x01 (User area in Data flash) |
| | 0x02 (Config area) |
| (1 bytee) | Start address |
| (4 bytes) | Example: 0001_0000h -> 0x00, 0x01, 0x00, 0x00 |
| (1 b) (too) | End address |
| (4 bytes) | Example: 001F_FFFFh -> 0x00, 0x1F, 0xFF, 0xFF |
| | Erase access unit (alignment) [bytes] |
| (4 bytes) *1 | Example: 32 KB (32768 bytes) |
| | -> 0x00, 0x00, 0x80, 0x00 |
| | Write access unit (alignment) [byte] |
| (4 bytes) | Example: 256 bytes |
| | -> 0x00, 0x00, 0x01, 0x00 |
| (1 byte) | Sum data |
| (1 byte) | 0x03 |
| | (1 byte) (1 byte) (1 byte) (1 byte) (4 bytes) (4 bytes) (4 bytes) *1 (4 bytes) (1 byte) |

Note: *1 If EAU is 0x00000000, Erase command is not available for the area.

3.4.12.4 Data Packet [Status ERR]

| S | L | L | R | S | S | Е |
|---|---|---|---|---|---|---|
| 0 | Ν | Ν | Е | Т | U | Т |
| D | н | L | S | S | М | Х |

| SOD | (1 byte) | 0x81 | |
|-----|----------|----------------------------------------------------------------------------------------------------------|--|
| LNH | (1 byte) | 0x00 | |
| LNL | (1 byte) | 0x02 | |
| RES | (1 byte) | 0xBB (ERR) | |
| STS | (1 byte) | Status code 0xC1 (Packet error) 0xC2 (Checksum error) 0xC3 (Flow error) 0xD0 (Address error) | |
| SUM | (1 byte) | Sum data | |
| ETX | (1 byte) | 0x03 | |

3.4.12.5 Status Code from Microcontroller [Priority High: 1 -> low: 10]

Table 26. Area Information Request Status Codes

| Condition | Status | Priority | Code |
|-------------------------------------------------------------------------|--------------|----------|------|
| If LNH and LNL in the received packet are different from defined values | Packet error | 3 | 0xC1 |
| If the received packet does not have ETX | | 1 | |
| If SUM in the received packet is different from the value calculated by | Checksum | 2 | 0xC2 |
| the boot firmware | error | | |
| If the state is Authentication phase | Flow error | 4 | 0xC3 |
| If NUM in the received packet is a nonexistent area number | Address | 5 | 0xD0 |
| | error | | |



3.5 Recommended Procedure for Flash Programmer

3.5.1 Beginning Communication



Figure 27. Beginning Communication



3.5.2 Total Area Erasure



Figure 28. Total Area Erasure

3.5.3 Acquisition of Device Information



Figure 29. Acquisition of Device Information

3.5.4 Code and Data in User Area Updates



Figure 30. Code and Data in User Area Updates

3.5.5 Configuration Data Updates



Figure 31. Configuration Data Updates



Website and Support

Visit the following URLs to learn about key elements of the RA family, download components and related documentation, and get support.

RA Product Information RA Product Support Forum RA Flexible Software Package Renesas Support www.renesas.com/ra/forum www.renesas.com/FSP www.renesas.com/support



Revision History

| | | Description | |
|------|-----------|-------------|-----------------------------|
| Rev. | Date | Page | Summary |
| 1.00 | Mar.02.20 | — | First release document |
| 1.10 | Oct.20.21 | 1, 6, 8 | Addition of RA4W1 and RA6T1 |



General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices. Proceeding a transport of the taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

6.

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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(Rev.4.0-1 November 2017)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

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